

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kai Leung FAN</td> <td>01/12/2009</td> </tr> <tr> <td>Ming Sang YEUNG</td> <td>01/12/2009</td> </tr> </tbody> </table>		Name	Execution Date	Kai Leung FAN	01/12/2009	Ming Sang YEUNG	01/12/2009
Name	Execution Date						
Kai Leung FAN	01/12/2009						
Ming Sang YEUNG	01/12/2009						
RECEIVING PARTY DATA							
Name:	Dongguan Anwell Digital Machinery Co., Ltd.						
Street Address:	6 Da Long Ru, ShiGu Village, Nanchen Dongguan						
City:	Guangdong Province						
State/Country:	CHINA						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11292919</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11292919		
Property Type	Number						
Application Number:	11292919						
CORRESPONDENCE DATA							
Fax Number:	(408)873-9249						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	4087778873						
Email:	joezheng88@sbcglobal.net						
Correspondent Name:	Joe Zheng						
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Address Line 4:	Cupertino, CALIFORNIA 95014						
ATTORNEY DOCKET NUMBER:	ANWL-088						
NAME OF SUBMITTER:	Joe Zheng						
Total Attachments: 1 source=Signed assignment recorded#page1.tif							

CH \$40.00 11292919

ASSIGNMENT OF PATENT APPLICATION

Whereas I, an undersigned inventor, have invented certain new and useful improvements as set forth in the patent application entitled:

Bubble-free techniques for bonding substrates

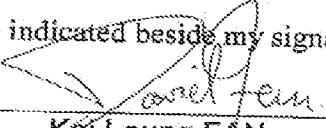
(Docket No. ANWELL-088), (check one)


- for which I have executed a U.S. patent application on even date herewith. (Accompanying)
 which bears U.S. application No.: 11/292,919 (US Pat. No.: 7,479,202 to be issued on 01/20/2009). (Not accompanying)
 which is a U.S. provisional application. (Accompanying)

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, an undersigned inventor, hereby:

- 1) Sell, assign and transfer to Dongguan Anwell Digital Machinery Co., Ltd. having a principal place of business at 6 Da Long Ru, ShiGu Village, Nanchen Dongguan, Guangdong Province, People's Republic of China ("ASSIGNEE"), the entire right, title and interest in any and all improvements and inventions disclosed in, applications based upon, and patents (including foreign patents and the right to claim priority) granted upon, the above-referenced application.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application or any division, continuation, substitute, renewal, re-examination or reissue thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application, as well as any derivative applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative, and shall be binding upon the inventor, as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that I have not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.
- 6) Authorize and request my representative to insert above the application No. in order to assist with recordal of this assignment.

Signed on the date indicated beside my signature:

1. Inventor Signature:  Date: 12 JAN 2009
Kai Leung FAN

2. Inventor Signature:  Date: 12 JAN 2009
Ming Sang YEUNG